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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	125
Number of Gates	36000
Voltage - Supply	3V ~ 3.6V, 4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a42mx24-fpq160">https://www.e-xfl.com/product-detail/microchip-technology/a42mx24-fpq160</a>

- VCCA = Power supply in volts (V)
- F = Switching frequency in megahertz (MHz)

### 3.4.4 Equivalent Capacitance

Equivalent capacitance is calculated by measuring ICC<sub>active</sub> at a specified frequency and voltage for each circuit component of interest. Measurements have been made over a range of frequencies at a fixed value of VCC. Equivalent capacitance is frequency-independent, so the results can be used over a wide range of operating conditions. Equivalent capacitance values are shown below.

### 3.4.5 C<sub>EQ</sub> Values for Microsemi MX FPGAs

Modules (C<sub>EQM</sub>) 3.5

Input Buffers (C<sub>EQI</sub>) 6.9

Output Buffers (C<sub>EQO</sub>) 18.2

Routed Array Clock Buffer Loads (C<sub>EQCR</sub>) 1.4

To calculate the active power dissipated from the complete design, the switching frequency of each part of the logic must be known. The equation below shows a piece-wise linear summation over all components.

$$\text{Power} = VCCA^2 * [(m \times C_{EQM} * f_m)_{\text{modules}} + (n * C_{EQI} * f_n)_{\text{inputs}} + (p * (C_{EQO} + C_L) * f_p)_{\text{outputs}} + 0.5 * (q_1 * C_{EQCR} * f_{q1})_{\text{routed\_clk1}} + (r_1 * f_{q1})_{\text{routed\_clk1}} + 0.5 * (q_2 * C_{EQCR} * f_{q2})_{\text{routed\_clk2}} + (r_2 * f_{q2})_{\text{routed\_clk2}}] \quad (2)$$

**EQ 3**

where:

m = Number of logic modules switching at frequency f<sub>m</sub>

n = Number of input buffers switching at frequency f<sub>n</sub>

p = Number of output buffers switching at frequency f<sub>p</sub>

q<sub>1</sub> = Number of clock loads on the first routed array clock

q<sub>2</sub> = Number of clock loads on the second routed array clock

r<sub>1</sub> = Fixed capacitance due to first routed array clock

r<sub>2</sub> = Fixed capacitance due to second routed array clock

C<sub>EQM</sub> = Equivalent capacitance of logic modules in pF

C<sub>EQI</sub> = Equivalent capacitance of input buffers in pF

C<sub>EQO</sub> = Equivalent capacitance of output buffers in pF

C<sub>EQCR</sub> = Equivalent capacitance of routed array clock in pF

C<sub>L</sub> = Output load capacitance in pF

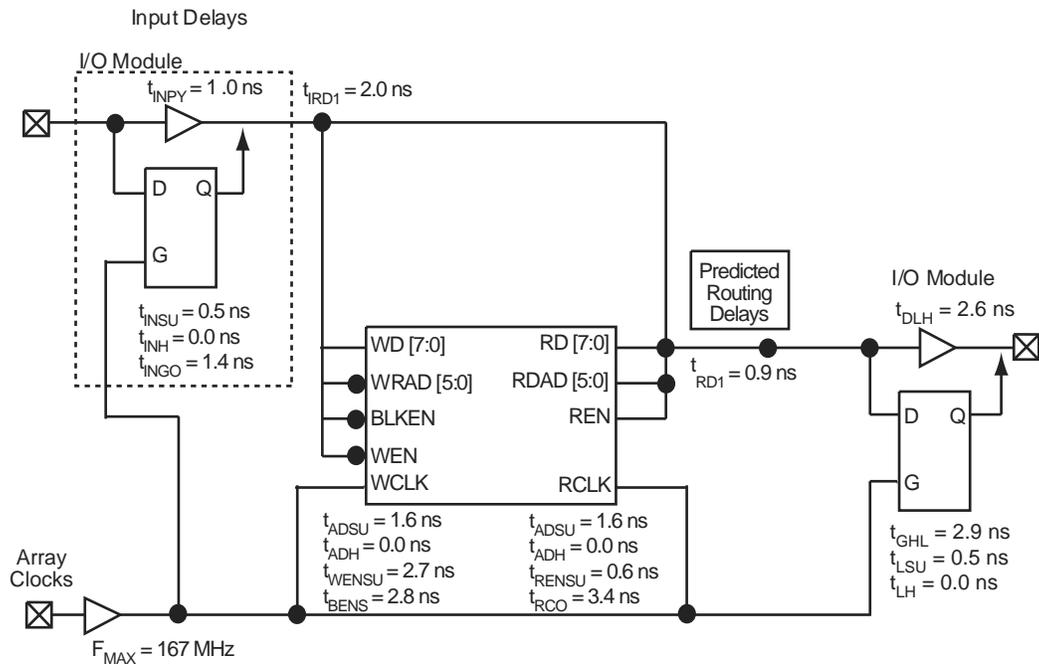
f<sub>m</sub> = Average logic module switching rate in MHz

f<sub>n</sub> = Average input buffer switching rate in MHz

f<sub>p</sub> = Average output buffer switching rate in MHz

f<sub>q1</sub> = Average first routed array clock rate in MHz

**Figure 20 • 42MX Timing Model (SRAM Functions)**

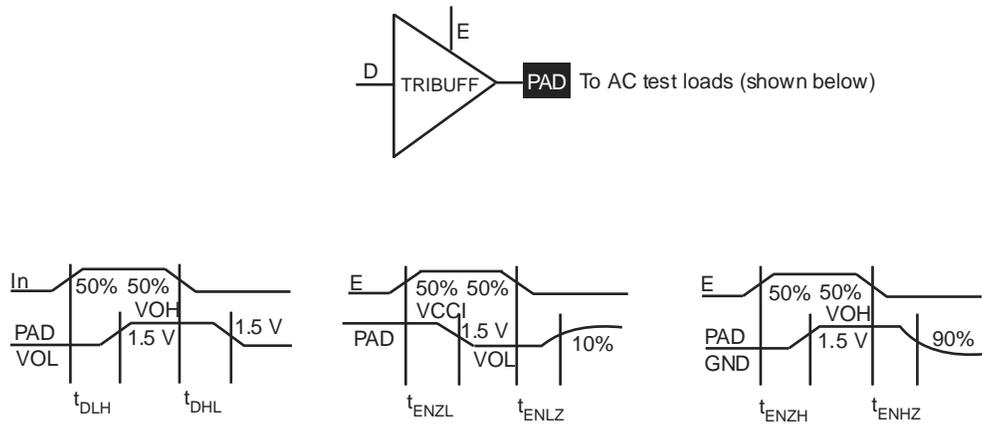


**Note:** Values are shown for A42MX36 –3 at 5.0 V worst-case commercial conditions.

### 3.10.1 Parameter Measurement

The following figures show parameter measurement details.

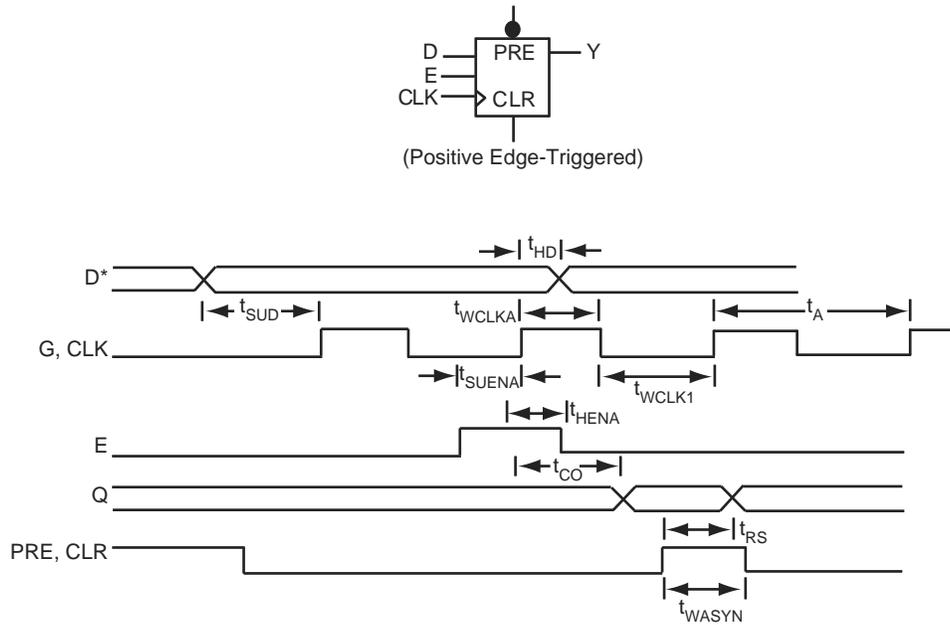
**Figure 21 • Output Buffer Delays**



### 3.10.2 Sequential Module Timing Characteristics

The following figure shows sequential module timing characteristics.

Figure 25 • Flip-Flops and Latches

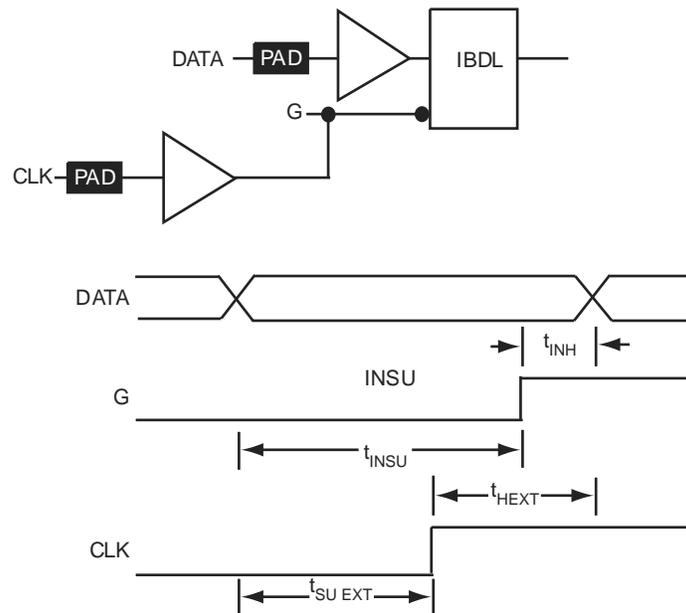


**Note:** \*D represents all data functions involving A, B, and S for multiplexed flip-flops.

### 3.10.3 Sequential Timing Characteristics

The following figures show sequential timing characteristics.

Figure 26 • Input Buffer Latches



**Table 38 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>WASYN</sub> Flip-Flop (Latch) Asynchronous Pulse Width	4.5		4.9		5.6		6.6		9.2		ns
t <sub>A</sub> Flip-Flop Clock Input Period	3.5		3.8		4.3		5.1		7.1		ns
t <sub>INH</sub> Input Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>INSU</sub> Input Buffer Latch Set-Up	0.3		0.3		0.4		0.4		0.6		ns
t <sub>OUTH</sub> Output Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>OUTSU</sub> Output Buffer Latch Set-Up	0.3		0.3		0.4		0.4		0.6		ns
f <sub>MAX</sub> Flip-Flop (Latch) Clock Frequency		268		244		224		195		117	MHz

**Table 38 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>TTL Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub>	Data-to-Pad HIGH	2.5	2.7	3.1	3.6	5.1	ns				
t <sub>DHL</sub>	Data-to-Pad LOW	2.9	3.2	3.6	4.3	6.0	ns				
t <sub>ENZH</sub>	Enable Pad Z to HIGH	2.6	2.9	3.3	3.9	5.5	ns				
t <sub>ENZL</sub>	Enable Pad Z to LOW	2.9	3.2	3.7	4.3	6.1	ns				
t <sub>ENHZ</sub>	Enable Pad HIGH to Z	4.9	5.4	6.2	7.3	10.2	ns				
t <sub>ENLZ</sub>	Enable Pad LOW to Z	5.3	5.9	6.7	7.9	11.1	ns				
t <sub>GLH</sub>	G-to-Pad HIGH	2.6	2.9	3.3	3.8	5.3	ns				
t <sub>GHL</sub>	G-to-Pad LOW	2.6	2.9	3.3	3.8	5.3	ns				
t <sub>LSU</sub>	I/O Latch Set-Up	0.5	0.5	0.6	0.7	1.0	ns				
t <sub>LH</sub>	I/O Latch Hold	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>LCO</sub>	I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading	5.2	5.8	6.6	7.7	10.8	ns				
t <sub>ACO</sub>	Array Clock-to-Out (Pad-to-Pad), 64 Clock Loading	7.4	8.2	9.3	10.9	15.3	ns				
d <sub>TLH</sub>	Capacity Loading, LOW to HIGH	0.03	0.03	0.03	0.04	0.06	ns/pF				
d <sub>THL</sub>	Capacity Loading, HIGH to LOW	0.04	0.04	0.04	0.05	0.07	ns/pF				

**Table 38 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>CMOS Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub>	Data-to-Pad HIGH	2.4	2.7	3.1	3.6	5.1	ns				
t <sub>DHL</sub>	Data-to-Pad LOW	2.9	3.2	3.6	4.3	6.0	ns				
t <sub>ENZH</sub>	Enable Pad Z to HIGH	2.7	2.9	3.3	3.9	5.5	ns				
t <sub>ENZL</sub>	Enable Pad Z to LOW	2.9	3.2	3.7	4.3	6.1	ns				
t <sub>ENHZ</sub>	Enable Pad HIGH to Z	4.9	5.4	6.2	7.3	10.2	ns				
t <sub>ENLZ</sub>	Enable Pad LOW to Z	5.3	5.9	6.7	7.9	11.1	ns				
t <sub>GLH</sub>	G-to-Pad HIGH	4.2	4.6	5.2	6.1	8.6	ns				
t <sub>GHL</sub>	G-to-Pad LOW	4.2	4.6	5.2	6.1	8.6	ns				
t <sub>LSU</sub>	I/O Latch Set-Up	0.5	0.5	0.6	0.7	1.0	ns				
t <sub>LH</sub>	I/O Latch Hold	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>LCO</sub>	I/O Latch Clock-to-Out (Pad-to-Pad), 64 Clock Loading	5.2	5.8	6.6	7.7	10.8	ns				
t <sub>ACO</sub>	Array Clock-to-Out ( Pad-to-Pad), 64 Clock Loading	7.4	8.2	9.3	10.9	15.3	ns				
d <sub>TLH</sub>	Capacity Loading, LOW to HIGH	0.03	0.03	0.03	0.04	0.06	ns/pF				
d <sub>THL</sub>	Capacity Loading, HIGH to LOW	0.04	0.04	0.04	0.05	0.07	ns/pF				

1. For dual-module macros, use t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, t<sub>CO</sub> + t<sub>RD1</sub> + t<sub>PDn</sub>, or t<sub>PD1</sub> + t<sub>RD1</sub> + t<sub>SUD</sub>, whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.
3. Data applies to macros based on the S-module. Timing parameters for sequential macros constructed from C-modules can be obtained from the Timer utility.
4. Set-up and hold timing parameters for the input buffer latch are defined with respect to the PAD and the D input. External setup/hold timing parameters must account for delay from an external PAD signal to the G inputs. Delay from an external PAD signal to the G input subtracts (adds) to the internal setup (hold) time.
5. Delays based on 35 pF loading

**Table 39 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Logic Module Propagation Delays<sup>1</sup></b>											
t <sub>PD1</sub>	Single Module	1.6	1.8	2.1	2.5	3.5	ns				
t <sub>CO</sub>	Sequential Clock-to-Q	1.8	2.0	2.3	2.7	3.8	ns				
t <sub>GO</sub>	Latch G-to-Q	1.7	1.9	2.1	2.5	3.5	ns				
t <sub>RS</sub>	Flip-Flop (Latch) Reset-to-Q	2.0	2.2	2.5	2.9	4.1	ns				
<b>Logic Module Predicted Routing Delays<sup>2</sup></b>											
t <sub>RD1</sub>	FO = 1 Routing Delay	1.0	1.1	1.2	1.4	2.0	ns				
t <sub>RD2</sub>	FO = 2 Routing Delay	1.3	1.4	1.6	1.9	2.7	ns				
t <sub>RD3</sub>	FO = 3 Routing Delay	1.6	1.8	2.0	2.4	3.3	ns				

**Table 39 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>RD4</sub> FO = 4 Routing Delay	1.9		2.1		2.4		2.9		4.0		ns
t <sub>RD8</sub> FO = 8 Routing Delay	3.2		3.6		4.1		4.8		6.7		ns
<b>Logic Module Sequential Timing<sup>3, 4</sup></b>											
t <sub>SUD</sub> Flip-Flop (Latch) Data Input Set-Up	0.5		0.5		0.6		0.7		0.9		ns
t <sub>HD</sub> Flip-Flop (Latch) Data Input Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>SUENA</sub> Flip-Flop (Latch) Enable Set-Up	0.6		0.6		0.7		0.8		1.2		ns
t <sub>HENA</sub> Flip-Flop (Latch) Enable Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>WCLKA</sub> Flip-Flop (Latch) Clock Active Pulse Width	4.7		5.3		6.0		7.0		9.8		ns
t <sub>WASYN</sub> Flip-Flop (Latch) Asynchronous Pulse Width	6.2		6.9		7.8		9.2		12.9		ns
t <sub>A</sub> Flip-Flop Clock Input Period	5.0		5.6		6.2		7.1		9.9		ns
t <sub>INH</sub> Input Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>INSU</sub> Input Buffer Latch Set-Up	0.3		0.3		0.3		0.4		0.6		ns
t <sub>OUTH</sub> Output Buffer Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>OUTSU</sub> Output Buffer Latch Set-Up	0.3		0.3		0.3		0.4		0.6		ns
f <sub>MAX</sub> Flip-Flop (Latch) Clock Frequency	161		146		135		117		70		MHz

**Table 39 • A42MX09 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, T<sub>J</sub> = 70°C)**

Parameter / Description			-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Input Module Propagation Delays</b>													
t <sub>INYH</sub>	Pad-to-Y HIGH		1.5	1.6	1.8	2.17	3.0	ns					
t <sub>INYL</sub>	Pad-to-Y LOW		1.2	1.3	1.4	1.7	2.4	ns					
t <sub>INGH</sub>	G to Y HIGH		1.8	2.0	2.3	2.7	3.7	ns					
t <sub>INGL</sub>	G to Y LOW		1.8	2.0	2.3	2.7	3.7	ns					
<b>Input Module Predicted Routing Delays<sup>2</sup></b>													
t <sub>IRD1</sub>	FO = 1 Routing Delay		2.8	3.2	3.6	4.2	5.9	ns					
t <sub>IRD2</sub>	FO = 2 Routing Delay		3.2	3.5	4.0	4.7	6.6	ns					
t <sub>IRD3</sub>	FO = 3 Routing Delay		3.5	3.9	4.4	5.2	7.3	ns					
t <sub>IRD4</sub>	FO = 4 Routing Delay		3.9	4.3	4.9	5.7	8.0	ns					
t <sub>IRD8</sub>	FO = 8 Routing Delay		5.2	5.8	6.6	7.7	10.8	ns					
<b>Global Clock Network</b>													
t <sub>CKH</sub>	Input LOW to HIGH	FO = 32	4.1	4.5	5.1	6.0	8.4	ns					
		FO = 256	4.5	5.0	5.6	6.7	9.3	ns					
t <sub>CKL</sub>	Input HIGH to LOW	FO = 32	5.0	5.5	6.2	7.3	10.2	ns					
		FO = 256	5.4	6.0	6.8	8.0	11.2	ns					
t <sub>PWH</sub>	Minimum Pulse Width HIGH	FO = 32	1.7	1.9	2.1	2.5	3.5	ns					
		FO = 256	1.9	2.1	2.3	2.7	3.8	ns					
t <sub>PWL</sub>	Minimum Pulse Width LOW	FO = 32	1.7	1.9	2.1	2.5	3.5	ns					
		FO = 256	1.9	2.1	2.3	2.7	3.8	ns					
t <sub>CKSW</sub>	Maximum Skew	FO = 32	0.4	0.5	0.5	0.6	0.9	ns					
		FO = 256	0.4	0.5	0.5	0.6	0.9	ns					
t <sub>SUEXT</sub>	Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	ns					
		FO = 256	0.0	0.0	0.0	0.0	0.0	ns					
t <sub>HEXT</sub>	Input Latch External Hold	FO = 32	3.3	3.7	4.2	4.9	6.9	ns					
		FO = 256	3.7	4.1	4.6	5.5	7.6	ns					
t <sub>P</sub>	Minimum Period	FO = 32	5.6	6.2	6.7	7.8	12.9	ns					
		FO = 256	6.1	6.8	7.4	8.5	14.2	ns					
f <sub>MAX</sub>	Maximum Frequency	FO = 32	177	161	148	129	77	MHz					
		FO = 256	161	146	135	117	70	MHz					

**Table 40 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

Parameter / Description		-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>RD3</sub>	FO = 3 Routing Delay		1.3		1.4		1.6		1.9		2.7	ns
t <sub>RD4</sub>	FO = 4 Routing Delay		1.6		1.7		2.0		2.3		3.2	ns
t <sub>RD8</sub>	FO = 8 Routing Delay		2.6		2.9		3.2		3.8		5.3	ns
<b>Logic Module Sequential Timing<sup>3,4</sup></b>												
t <sub>SUD</sub>	Flip-Flop (Latch) Data Input Set-Up		0.3		0.4		0.4		0.5		0.7	ns
t <sub>HD</sub>	Flip-Flop (Latch) Data Input Hold		0.0		0.0		0.0		0.0		0.0	ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up		0.7		0.8		0.9		1.0		1.4	ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold		0.0		0.0		0.0		0.0		0.0	ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width		3.4		3.8		4.3		5.0		7.1	ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width		4.5		5.0		5.6		6.6		9.2	ns
t <sub>A</sub>	Flip-Flop Clock Input Period		6.8		7.6		8.6		10.1		14.1	ns
t <sub>INH</sub>	Input Buffer Latch Hold		0.0		0.0		0.0		0.0		0.0	ns
t <sub>INSU</sub>	Input Buffer Latch Set-Up		0.5		0.5		0.6		0.7		1.0	ns
t <sub>OUTH</sub>	Output Buffer Latch Hold		0.0		0.0		0.0		0.0		0.0	ns
t <sub>OUTSU</sub>	Output Buffer Latch Set-Up		0.5		0.5		0.6		0.7		1.0	ns
f <sub>MAX</sub>	Flip-Flop (Latch) Clock Frequency		215		195		179		156		94	MHz
<b>Input Module Propagation Delays</b>												
t <sub>INYH</sub>	Pad-to-Y HIGH		1.1		1.2		1.3		1.6		2.2	ns
t <sub>INYL</sub>	Pad-to-Y LOW		0.8		0.9		1.0		1.2		1.7	ns
t <sub>INGH</sub>	G to Y HIGH		1.4		1.6		1.8		2.1		2.9	ns
t <sub>INGL</sub>	G to Y LOW		1.4		1.6		1.8		2.1		2.9	ns
<b>Input Module Predicted Routing Delays<sup>2</sup></b>												
t <sub>IRD1</sub>	FO = 1 Routing Delay		1.8		2.0		2.3		2.7		4.0	ns
t <sub>IRD2</sub>	FO = 2 Routing Delay		2.1		2.3		2.6		3.1		4.3	ns
t <sub>IRD3</sub>	FO = 3 Routing Delay		2.3		2.6		3.0		3.5		4.9	ns
t <sub>IRD4</sub>	FO = 4 Routing Delay		2.6		3.0		3.3		3.9		5.4	ns
t <sub>IRD8</sub>	FO = 8 Routing Delay		3.6		4.0		4.6		5.4		7.5	ns
<b>Global Clock Network</b>												
t <sub>CKH</sub>	Input LOW to HIGH	FO = 32	2.6		2.9		3.3		3.9		5.4	ns
		FO = 384	2.9		3.2		3.6		4.3		6.0	ns
t <sub>CKL</sub>	Input HIGH to LOW	FO = 32	3.8		4.2		4.8		5.6		7.8	ns
		FO = 384	4.5		5.0		5.6		6.6		9.2	ns
t <sub>PWH</sub>	Minimum Pulse Width HIGH	FO = 32	3.2		3.5		4.0		4.7		6.6	ns
		FO = 384	3.7		4.1		4.6		5.4		7.6	ns

**Table 42 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Input Module Propagation Delays</b>											
t <sub>INPY</sub>	Input Data Pad-to-Y		1.0	1.1	1.3	1.5	2.1			ns	
t <sub>INGO</sub>	Input Latch Gate-to-Output		1.3	1.4	1.6	1.9	2.6			ns	
t <sub>INH</sub>	Input Latch Hold		0.0	0.0	0.0	0.0	0.0			ns	
t <sub>INSU</sub>	Input Latch Set-Up		0.5	0.5	0.6	0.7	1.0			ns	
t <sub>ILA</sub>	Latch Active Pulse Width		4.7	5.2	5.9	6.9	9.7			ns	

**Table 44 • A42MX36 Timing Characteristics (Nominal 5.0 V Operation)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Logic Module Combinatorial Functions<sup>1</sup></b>											
t <sub>PD</sub>	Internal Array Module Delay	1.3	1.5	1.7	2.0	2.7	ns				
t <sub>PDD</sub>	Internal Decode Module Delay	1.6	1.8	2.0	2.4	3.3	ns				
<b>Logic Module Predicted Routing Delays<sup>2</sup></b>											
t <sub>RD1</sub>	FO = 1 Routing Delay	0.9	1.0	1.2	1.4	2.0	ns				
t <sub>RD2</sub>	FO = 2 Routing Delay	1.3	1.4	1.6	1.9	2.7	ns				
t <sub>RD3</sub>	FO = 3 Routing Delay	1.6	1.8	2.0	2.4	3.4	ns				
t <sub>RD4</sub>	FO = 4 Routing Delay	2.0	2.2	2.5	2.9	4.1	ns				
t <sub>RD5</sub>	FO = 8 Routing Delay	3.3	3.7	4.2	4.9	6.9	ns				
t <sub>RDD</sub>	Decode-to-Output Routing Delay	0.3	0.4	0.4	0.5	0.7	ns				
<b>Logic Module Sequential Timing<sup>3, 4</sup></b>											
t <sub>CO</sub>	Flip-Flop Clock-to-Output	1.3	1.4	1.6	1.9	2.7	ns				
t <sub>GO</sub>	Latch Gate-to-Output	1.3	1.4	1.6	1.9	2.7	ns				
t <sub>SUD</sub>	Flip-Flop (Latch) Set-Up Time	0.3	0.3	0.4	0.5	0.7	ns				
t <sub>HD</sub>	Flip-Flop (Latch) Hold Time	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>RO</sub>	Flip-Flop (Latch) Reset-to-Output	1.6	1.7	2.0	2.3	3.2	ns				
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	0.7	0.8	0.9	1.0	1.4	ns				
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width	3.3	3.7	4.2	4.9	6.9	ns				
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width	4.4	4.8	5.5	6.4	9.0	ns				
<b>Synchronous SRAM Operations</b>											
t <sub>RC</sub>	Read Cycle Time	6.8	7.5	8.5	10.0	14.0	ns				
t <sub>WC</sub>	Write Cycle Time	6.8	7.5	8.5	10.0	14.0	ns				
t <sub>RCKHL</sub>	Clock HIGH/LOW Time	3.4	3.8	4.3	5.0	7.0	ns				
t <sub>RCO</sub>	Data Valid After Clock HIGH/LOW	3.4	3.8	4.3	5.0	7.0	ns				
t <sub>ADSU</sub>	Address/Data Set-Up Time	1.6	1.8	2.0	2.4	3.4	ns				
<b>Synchronous SRAM Operations (continued)</b>											
t <sub>ADH</sub>	Address/Data Hold Time	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>RENSU</sub>	Read Enable Set-Up	0.6	0.7	0.8	0.9	1.3	ns				
t <sub>RENH</sub>	Read Enable Hold	3.4	3.8	4.3	5.0	7.0	ns				
t <sub>WENSU</sub>	Write Enable Set-Up	2.7	3.0	3.4	4.0	5.6	ns				
t <sub>WENH</sub>	Write Enable Hold	0.0	0.0	0.0	0.0	0.0	ns				
t <sub>BENS</sub>	Block Enable Set-Up	2.8	3.1	3.5	4.1	5.7	ns				
t <sub>BENH</sub>	Block Enable Hold	0.0	0.0	0.0	0.0	0.0	ns				

**Table 47 • PL44**

<b>PL44</b>		
<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>
21	GND	GND
22	I/O	I/O
23	I/O	I/O
24	I/O	I/O
25	VCC	VCC
26	I/O	I/O
27	I/O	I/O
28	I/O	I/O
29	I/O	I/O
30	I/O	I/O
31	I/O	I/O
32	GND	GND
33	CLK, I/O	CLK, I/O
34	MODE	MODE
35	VCC	VCC
36	SDI, I/O	SDI, I/O
37	DCLK, I/O	DCLK, I/O
38	PRA, I/O	PRA, I/O
39	PRB, I/O	PRB, I/O
40	I/O	I/O
41	I/O	I/O
42	I/O	I/O
43	GND	GND
44	I/O	I/O

**Table 51 • PQ144**

<b>PQ144</b>	
<b>Pin Number</b>	<b>A42MX09 Function</b>
43	I/O
44	GNDQ
45	GNDI
46	NC
47	I/O
48	I/O
49	I/O
50	I/O
51	I/O
52	I/O
53	I/O
54	VCC
55	VCCI
56	NC
57	I/O
58	I/O
59	I/O
60	I/O
61	I/O
62	I/O
63	I/O
64	GND
65	GNDI
66	I/O
67	I/O
68	I/O
69	I/O
70	I/O
71	SDO
72	I/O
73	I/O
74	I/O
75	I/O
76	I/O
77	I/O
78	I/O
79	GNDQ

**Table 52 • PQ160**

<b>PQ160</b>			
<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
58	VCCI	VCCI	VCCI
59	GND	GND	GND
60	VCCA	VCCA	VCCA
61	LP	LP	LP
62	I/O	I/O	TCK, I/O
63	I/O	I/O	I/O
64	GND	GND	GND
65	I/O	I/O	I/O
66	I/O	I/O	I/O
67	I/O	I/O	I/O
68	I/O	I/O	I/O
69	GND	GND	GND
70	NC	I/O	I/O
71	I/O	I/O	I/O
72	I/O	I/O	I/O
73	I/O	I/O	I/O
74	I/O	I/O	I/O
75	NC	I/O	I/O
76	I/O	I/O	I/O
77	NC	I/O	I/O
78	I/O	I/O	I/O
79	NC	I/O	I/O
80	GND	GND	GND
81	I/O	I/O	I/O
82	SDO, I/O	SDO, I/O	SDO, TDO, I/O
83	I/O	I/O	WD, I/O
84	I/O	I/O	WD, I/O
85	I/O	I/O	I/O
86	NC	VCCI	VCCI
87	I/O	I/O	I/O
88	I/O	I/O	WD, I/O
89	GND	GND	GND
90	NC	I/O	I/O
91	I/O	I/O	I/O
92	I/O	I/O	I/O
93	I/O	I/O	I/O
94	I/O	I/O	I/O

**Table 52 • PQ160**

<b>PQ160</b>			
<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
132	I/O	I/O	I/O
133	I/O	I/O	I/O
134	I/O	I/O	I/O
135	NC	VCCA	VCCA
136	I/O	I/O	I/O
137	I/O	I/O	I/O
138	NC	VCCA	VCCA
139	VCCI	VCCI	VCCI
140	GND	GND	GND
141	NC	I/O	I/O
142	I/O	I/O	I/O
143	I/O	I/O	I/O
144	I/O	I/O	I/O
145	GND	GND	GND
146	NC	I/O	I/O
147	I/O	I/O	I/O
148	I/O	I/O	I/O
149	I/O	I/O	I/O
150	NC	VCCA	VCCA
151	NC	I/O	I/O
152	NC	I/O	I/O
153	NC	I/O	I/O
154	NC	I/O	I/O
155	GND	GND	GND
156	I/O	I/O	I/O
157	I/O	I/O	I/O
158	I/O	I/O	I/O
159	MODE	MODE	MODE
160	GND	GND	GND

**Table 56 • VQ100**

<b>VQ100</b>		
<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>
57	I/O	I/O
58	I/O	I/O
59	I/O	I/O
60	I/O	I/O
61	I/O	I/O
62	LP	LP
63	VCCA	VCCA
64	VCCI	VCCI
65	VCCA	VCCA
66	I/O	I/O
67	I/O	I/O
68	I/O	I/O
69	I/O	I/O
70	GND	GND
71	I/O	I/O
72	I/O	I/O
73	I/O	I/O
74	I/O	I/O
75	I/O	I/O
76	I/O	I/O
77	SDI, I/O	SDI, I/O
78	I/O	I/O
79	I/O	I/O
80	I/O	I/O
81	I/O	I/O
82	GND	GND
83	I/O	I/O
84	I/O	I/O
85	PRA, I/O	PRA, I/O
86	I/O	I/O
87	CLKA, I/O	CLKA, I/O
88	VCCA	VCCA
89	I/O	I/O
90	CLKB, I/O	CLKB, I/O
91	I/O	I/O
92	PRB, I/O	PRB, I/O

**Table 57 • TQ176**

<b>TQ176</b>			
<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
84	I/O	I/O	WD, I/O
85	I/O	I/O	WD, I/O
86	NC	I/O	I/O
87	SDO, I/O	SDO, I/O	SDO, TDO, I/O
88	I/O	I/O	I/O
89	GND	GND	GND
90	I/O	I/O	I/O
91	I/O	I/O	I/O
92	I/O	I/O	I/O
93	I/O	I/O	I/O
94	I/O	I/O	I/O
95	I/O	I/O	I/O
96	NC	I/O	I/O
97	NC	I/O	I/O
98	I/O	I/O	I/O
99	I/O	I/O	I/O
100	I/O	I/O	I/O
101	NC	NC	I/O
102	I/O	I/O	I/O
103	NC	I/O	I/O
104	I/O	I/O	I/O
105	I/O	I/O	I/O
106	GND	GND	GND
107	NC	I/O	I/O
108	NC	I/O	TCK, I/O
109	LP	LP	LP
110	VCCA	VCCA	VCCA
111	GND	GND	GND
112	VCCI	VCCI	VCCI
113	VCCA	VCCA	VCCA
114	NC	I/O	I/O
115	NC	I/O	I/O
116	NC	VCCA	VCCA
117	I/O	I/O	I/O
118	I/O	I/O	I/O
119	I/O	I/O	I/O
120	I/O	I/O	I/O

**Table 58 • CQ208**

<b>CQ208</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
185	I/O
186	CLKB, I/O
187	I/O
188	PRB, I/O
189	I/O
190	WD, I/O
191	WD, I/O
192	I/O
193	I/O
194	WD, I/O
195	WD, I/O
196	QCLKC, I/O
197	I/O
198	I/O
199	I/O
200	I/O
201	I/O
202	VCCI
203	WD, I/O
204	WD, I/O
205	I/O
206	I/O
207	DCLK, I/O
208	I/O

**Table 59 • CQ256**

<b>CQ256</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
170	VCCA
171	I/O
172	I/O
173	I/O
174	I/O
175	I/O
176	I/O
177	I/O
178	I/O
179	I/O
180	GND
181	I/O
182	I/O
183	I/O
184	I/O
185	I/O
186	I/O
187	I/O
188	MODE
189	VCCA
190	GND
191	NC
192	NC
193	NC
194	I/O
195	DCLK, I/O
196	I/O
197	I/O
198	I/O
199	WD, I/O
200	WD, I/O
201	VCCI
202	I/O
203	I/O
204	I/O
205	I/O
206	GND

**Figure 53 • CQ172****Table 62 • CQ172**

CQ172	
Pin Number	A42MX16 Function
1	MODE
2	I/O
3	I/O
4	I/O
5	I/O
6	I/O
7	GND
8	I/O
9	I/O
10	I/O
11	I/O
12	VCC
13	I/O
14	I/O
15	I/O
16	I/O
17	GND
18	I/O
19	I/O
20	I/O